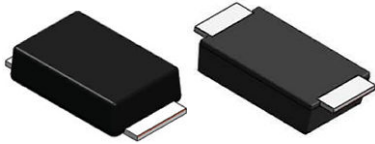




## Hyperfast Rectifier, 2 A FRED Pt®

### eSMP® Series



Top View

Bottom View

SlimSMAW (DO-221AD)

### FEATURES

- Low profile package
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compatible to SOD-128 package case outline
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



RoHS COMPLIANT HALOGEN FREE

### DESIGN SUPPORT TOOLS

[click logo to get started](#)



### DESCRIPTION / APPLICATIONS

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber industrial, and automotive applications.

### MECHANICAL DATA

**Case:** SlimSMAW (DO-221AD)

Molding compound meets UL 94 V-0 flammability rating  
Halogen-free, RoHS-compliant

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

**Polarity:** color band denotes the cathode end

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 A
$V_R$	100 V, 200 V
$V_F$ at $I_F$	0.69 V
$I_{FSM}$	60 A
$t_{rr}$ (typ.)	15 ns
$T_J$ max.	175 °C
Package	SlimSMAW (DO-221AD)
Circuit configuration	Single

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	VS-2EYH01-M3	$V_{RRM}$	100	V
	VS-2EYH02-M3		200	
Average rectified forward current	$I_{F(AV)}$ (1)	$T_C = 151\text{ °C}$	2	A
Non-repetitive peak surge current	$I_{FSM}$	$T_J = 25\text{ °C}$ , 10 ms sine pulse wave	60	
Operating junction and storage temperatures	$T_J, T_{Stg}$		-55 to +175	°C

#### Note

(1) Mounted on infinite heatsink

ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 100\text{ }\mu\text{A}$	100	-	-	V	
			200	-	-		
Forward voltage, per diode	$V_F$	$I_F = 2\text{ A}$	-	0.86	0.93		
		$I_F = 2\text{ A}, T_J = 150\text{ °C}$	-	0.69	0.75		
Reverse leakage current, per diode	$I_R$	$V_R = V_R$ rated	-	-	2	$\mu\text{A}$	
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	-	20		
Junction capacitance	$C_T$	$V_R = 200\text{ V}$	-	12	-	pF	



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Reverse recovery time	$t_{rr}$	$I_F = 1.0\text{ A}$ , $di_F/dt = 50\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	22	-	ns	
		$I_F = 1.0\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	15	-		
		$I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$	-	-	28		
		$T_J = 25\text{ }^\circ\text{C}$	-	16	-		
		$T_J = 125\text{ }^\circ\text{C}$	-	26	-		
Peak recovery current	$I_{RRM}$	$I_F = 2\text{ A}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ , $V_R = 100\text{ V}$	$T_J = 25\text{ }^\circ\text{C}$	-	2.7	-	A
			$T_J = 125\text{ }^\circ\text{C}$	-	3.4	-	
Reverse recovery charge	$Q_{rr}$		$T_J = 25\text{ }^\circ\text{C}$	-	20	-	nC
			$T_J = 125\text{ }^\circ\text{C}$	-	43	-	

<b>THERMAL - MECHANICAL SPECIFICATIONS</b>						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$		-55	-	175	$^\circ\text{C}$
Thermal resistance, junction to mount	$R_{thJM}^{(1)}$	Infinite heatsink	-	12	15	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient	$R_{thJA}$	Device mounted on FR4 PCB, 2 oz. standard footprint	-	120	150	
Marking device	VS-2EYH01-M3	Case style SlimSMAW (DO-221AD)	2H1			
	VS-2EYH02-M3		2H2			

**Note**

(1) Thermal resistance junction to mount follows JEDEC® 51-14 transient dual interface test method (TDIM)

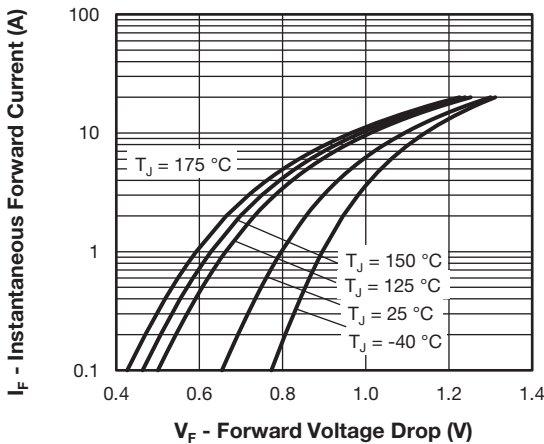


Fig. 1 - Typical Forward Voltage Drop Characteristics

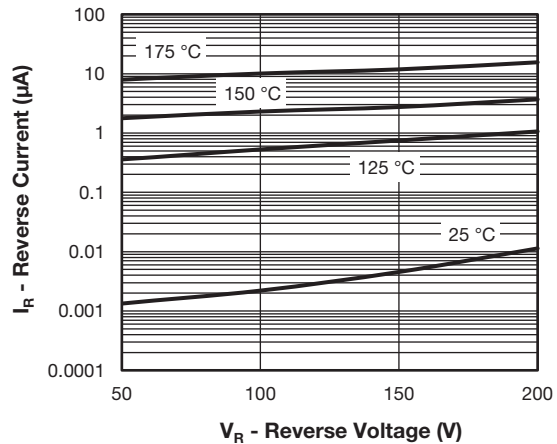


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

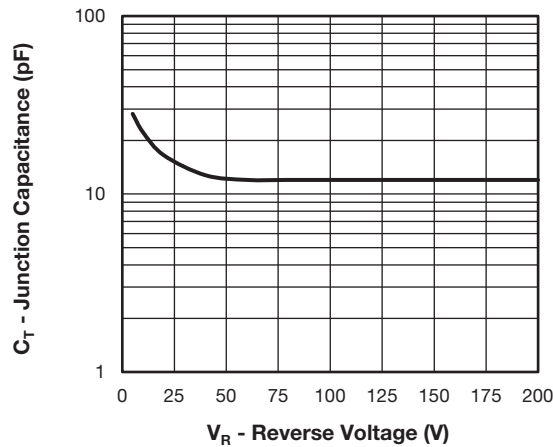


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

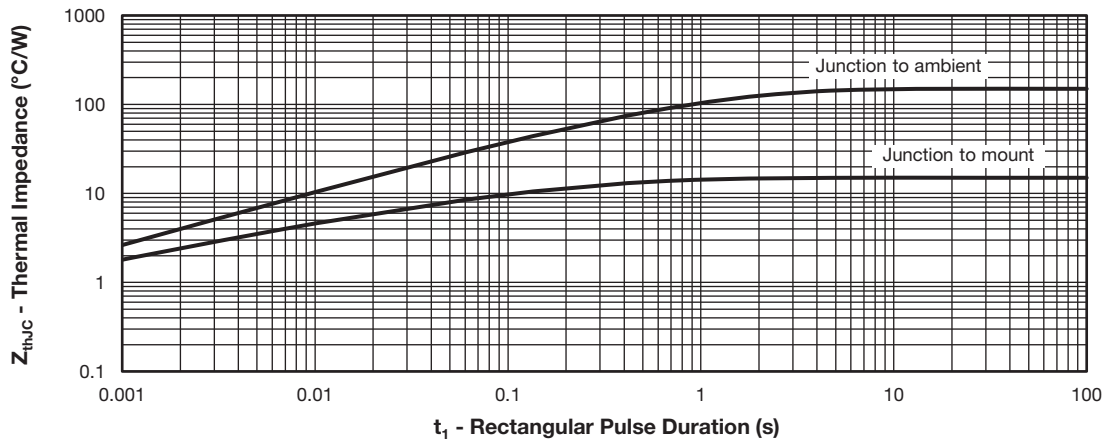


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

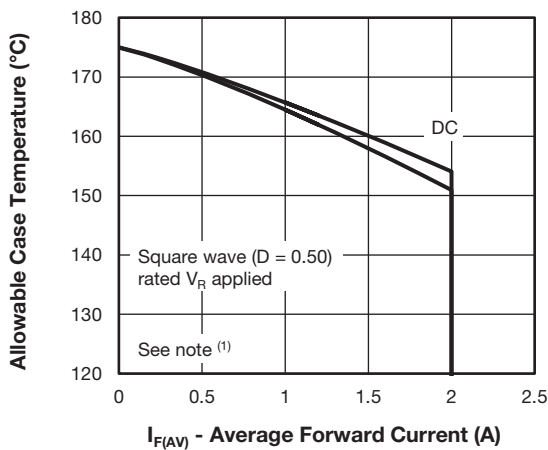


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

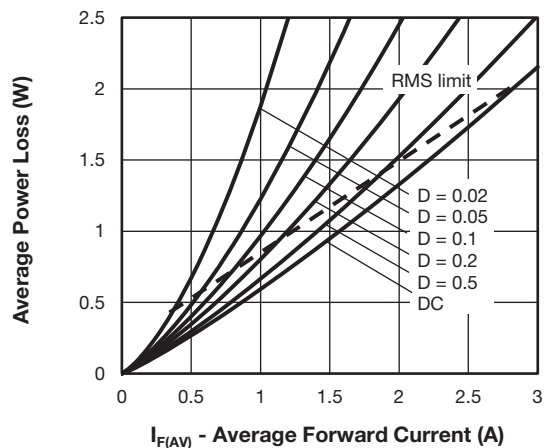


Fig. 6 - Forward Power Loss Characteristics

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;
- $P_d$  = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 5);
- $P_{dREV}$  = inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = rated  $V_R$

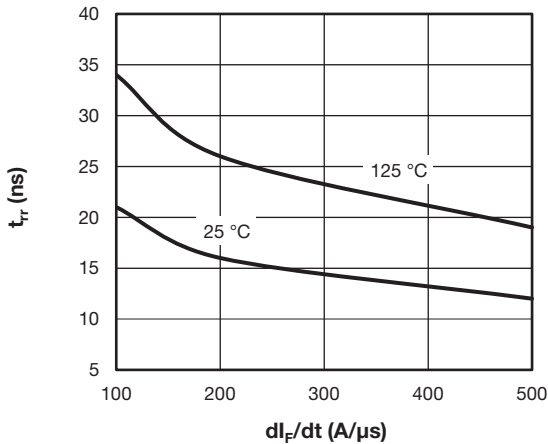


Fig. 7 - Typical Reverse Recovery Time vs.  $di_F/dt$

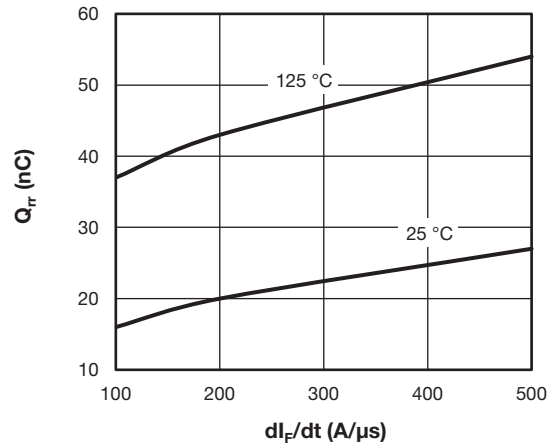


Fig. 8 - Typical Stored Charge vs.  $di_F/dt$

**ORDERING INFORMATION TABLE**

Device code	<b>VS-</b>	<b>2</b>	<b>E</b>	<b>Y</b>	<b>H</b>	<b>02</b>	<b>-</b>	<b>M3</b>
	①	②	③	④	⑤	⑥		⑦
	<b>1</b>	<b>2</b>	<b>3</b>	<b>4</b>	<b>5</b>	<b>6</b>		<b>7</b>
	-	-	-	-	-	-		-
	Vishay Semiconductors product							
	Current rating (2 = 2 A)							
	Circuit configuration:							
	E = single diode							
	Y = SlimSMAW (DO-221AD)							
	Process type,							
	H = hyperfast recovery							
	Voltage code (02 = 200 V)							
	M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free							

<b>ORDERING INFORMATION</b> (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	PACKAGING DESCRIPTION
VS-2EYH01-M3/H	0.033	H	3500	7" diameter plastic tape and reel
VS-2EYH01-M3/I	0.033	I	14 000	13" diameter plastic tape and reel
VS-2EYH02-M3/H	0.033	H	3500	7" diameter plastic tape and reel
VS-2EYH02-M3/I	0.033	I	14 000	13" diameter plastic tape and reel

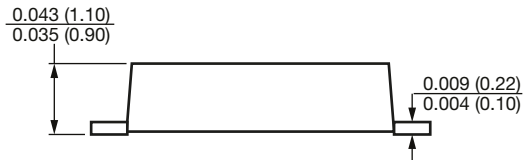
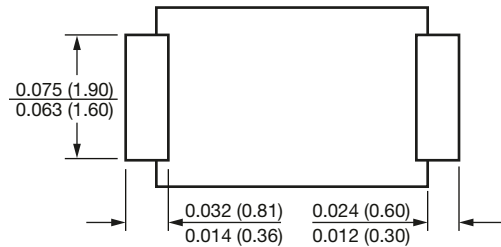
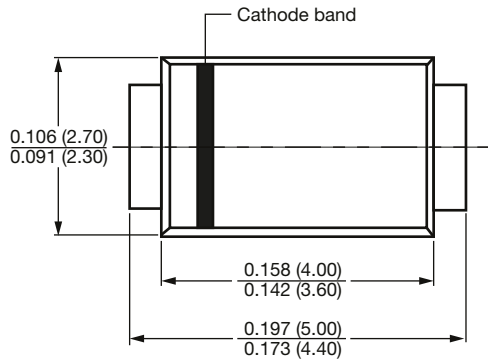
<b>LINKS TO RELATED DOCUMENTS</b>	
Dimensions	<a href="http://www.vishay.com/doc?96582">www.vishay.com/doc?96582</a>
Part marking information	<a href="http://www.vishay.com/doc?95562">www.vishay.com/doc?95562</a>
Packaging information	<a href="http://www.vishay.com/doc?88869">www.vishay.com/doc?88869</a>
SPIICE model	<a href="http://www.vishay.com/doc?96585">www.vishay.com/doc?96585</a>



## SlimSMAW (DO-221AD)

**DIMENSIONS** in inches (millimeters)

### SlimSMAW (DO-221AD)



**Mounting pad layout**



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